

# GPU SuperServer SYS-421GE-TNHR2-LCC

DP Intel 4U Liquid-Cooled System with NVIDIA HGX H100/H200 8-GPU (onsite service is required for liquid-cooling)



More details here

## Key Applications

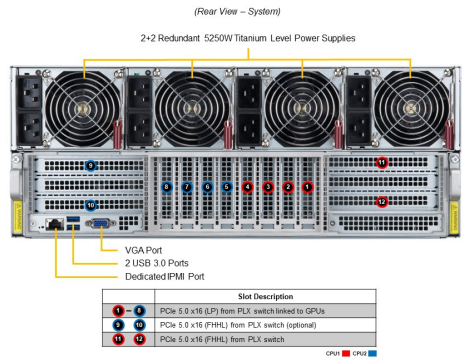
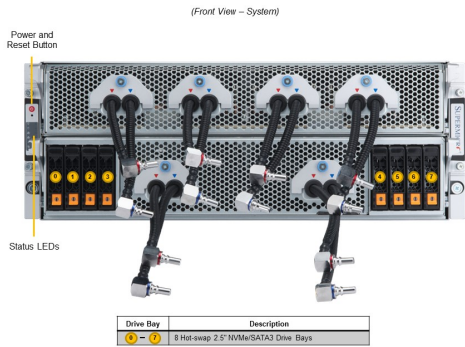
High Performance Computing, AI/Deep Learning Training, Industrial Automation, Retail, Healthcare, Conversational AI, Business Intelligence & Analytics, Drug Discovery, Climate and Weather Modeling, Finance & Economics,

## Key Features

- 5th/4th Gen Intel® Xeon® Scalable processor support;
- 32 DIMM slots Up to 8TB: 32x 256 GB DRAM Memory Type: 5600MTs ECC DDR5;
- 8 PCIe Gen 5.0 X16 LP  
2 PCIe Gen 5.0 X16 FHHL Slots, 2 PCIe Gen 5.0 X16 FHHL Slots (optional);
- Flexible networking options;
- 2 M.2 NVMe for boot drive only  
Optional: 8x 2.5" Hot-swap SATA drive bays  
8x 2.5" Hot-swap NVMe drive bays;
- 4 heavy duty fans with optimal fan speed control;
- 4x 5250W(2+2) Redundant Power Supplies, Titanium Level;



Form Factor	4U Rackmount Enclosure: 449 x 174 x 842mm (17.6" x 6.85" x 33.2") Package: 1216 x 330 x 670mm (48" x 13" x 26.4")
Processor	Dual Socket E (LGA-4677) 5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable processors Supports Intel Xeon CPU Max Series with high bandwidth memory (HBM) 64C/128T; 320MB Cache per CPU
GPU	Max GPU Count: Up to 8 onboard GPUs Supported GPU: NVIDIA SXM: HGX H100 8-GPU (80GB), HGX H200 8-GPU (141GB) CPU-GPU Interconnect: PCIe 5.0 x16 CPU-to-GPU Interconnect GPU-GPU Interconnect: NVIDIA® NVLink® with NVSwitch™
System Memory	Slot Count: 32 DIMM slots Max Memory (1DPC): 4TB 5600MT/s ECC DDR5 RDIMM Max Memory (2DPC): 8TB 4400MT/s ECC DDR5 RDIMM
Drive Bays Configuration	Default: Total 8 bays <ul style="list-style-type: none"> <li>• 8 front hot-swap 2.5" NVMe drive bays</li> </ul> M.2: 2 M.2 NVMe slots (M-key)
Expansion Slots	Default <ul style="list-style-type: none"> <li>• 8 PCIe 5.0 x16 LP slots</li> <li>• 2 PCIe 5.0 x16 FHHL slots</li> </ul> Option A <ul style="list-style-type: none"> <li>• 8 PCIe 5.0 x16 LP slots</li> <li>• 4 PCIe 5.0 x16 FHHL slots</li> </ul>
On-Board Devices	Chipset: Intel® C741 Network Connectivity: 2 SFP28 25GbE with Broadcom® BCM57414 (optional) 2 RJ45 10GbE with Intel® X710-AT2 (optional)
Input / Output	1 VGA port



System Cooling	<p>Fans: 4 Fan 8cm Fan(s)</p> <p>Liquid Cooling: Direct to Chip (D2C) Cold Plate (optional)</p>
Power Supply	4x 5250W Redundant (2 + 2) power supplies
System BIOS	BIOS Type: AMI 32MB SPI Flash EEPROM
Management	<p>SuperCloud Composer; Supermicro Server Manager (SSM); Supermicro Update Manager (SUM); Supermicro SuperDoctor® 5 (SD5); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!</p>
PC Health Monitoring	<p>CPU: Monitors for CPU Cores, Chipset Voltages, Memory</p> <p>8+4 Phase-switching voltage regulator</p> <p>FAN: Fans with tachometer monitoring</p> <p>Status monitor for speed control</p> <p>Pulse Width Modulated (PWM) fan connectors</p> <p>Temperature: Monitoring for CPU and chassis environment</p> <p>Thermal Control for fan connectors</p>
Dimensions and Weight	<p>Weight: Gross Weight: 138.89 lbs (63 kg)</p> <p>Net Weight: 80.03 lbs (53 kg)</p> <p>Available Color: Silver</p>
Operating Environment	<p>Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F)</p> <p>Non-operating Temperature: -40°C to 60°C (-40°F to 140°F)</p> <p>Operating Relative Humidity: 8% to 90% (non-condensing)</p> <p>Non-operating Relative Humidity: 5% to 95% (non-condensing)</p>
Motherboard	<a href="#">Super X13DEG-M</a>
Chassis	CSE-GP401TS-R000NP